

## PT7744—3.3V

20 Amp "Current Booster" for PT7712  
Integrated Switching Regulator

 **Power Trends Products**  
from Texas Instruments



**SLTS089**

(Revised 6/30/2000)

### Description

The PT7744 is a 20 Amp "Current Booster" for the PT7712 housed in the same 27-pin SIP package.

Multiple PT7744 boosters will operate in parallel with one PT7712 product, boosting output current in increments of 20A. Combinations of a PT7712 regulator and PT7744 current boosters can supply power for virtually any multiple mega-processor application.

A PT7744 current booster adds a

parallel output stage that is driven directly by the regulator. This allows the system to run in perfect synchronization to provide a low noise solution.

The PT7744 only operates in combination with a PT7712 series regulator, and is not a stand-alone product. Please refer to the PT7712 data sheet for the performance specifications.

The booster uses the same 27-pin case and has the same package options as its companion converter.

### Features

- 20A Current Boost
- Tracks  $V_o$  of a PT7712
- High Efficiency
- Input Voltage Range: 3.1V to 3.6V
- Synchronized with PT7712
- 27-pin SIP Package
- Solderable Copper Case
- Connect up to 2 in Parallel for 60 Amps

### Pin-Out Information

| Pin | Function       | Pin | Function       |
|-----|----------------|-----|----------------|
| 1   | Do not connect | 14  | GND            |
| 2   | Do not connect | 15  | GND            |
| 3   | Do not connect | 16  | GND            |
| 4   | Do not connect | 17  | GND            |
| 5   | Do not connect | 18  | GND            |
| 6   | Do not connect | 19  | GND            |
| 7   | $V_{in}$       | 20  | $V_{out}$      |
| 8   | $V_{in}$       | 21  | $V_{out}$      |
| 9   | $V_{in}$       | 22  | $V_{out}$      |
| 10  | $V_{in}$       | 23  | $V_{out}$      |
| 11  | $V_{in}$       | 24  | $V_{out}$      |
| 12  | Do not connect | 25  | $V_{out}$      |
| 13  | GND            | 26  | Do not connect |
|     |                | 27  | Master Sync In |

### Ordering Information

#### PT7744□

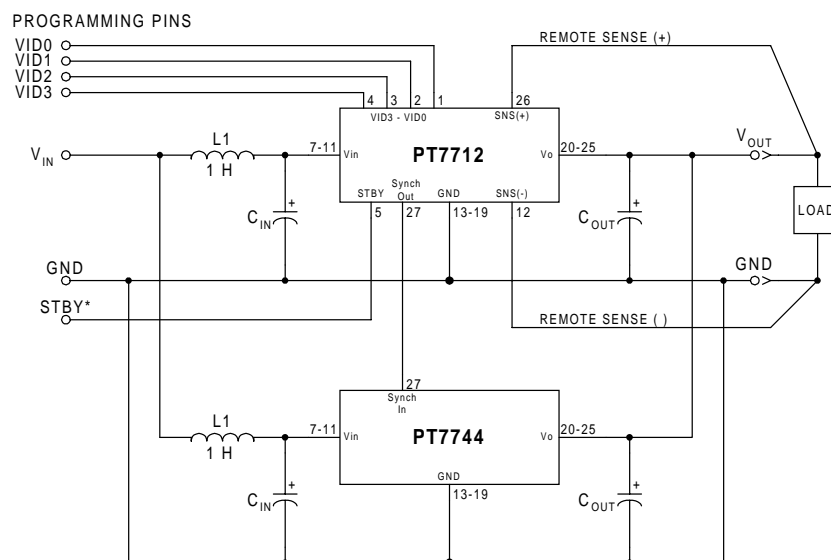
(For dimensions and PC Board layout, see Package Styles 1420 and 1430.)

#### PT Series Suffix (PT1234X)

#### Case/Pin Configuration

|                          |          |
|--------------------------|----------|
| Vertical Through-Hole    | <b>N</b> |
| Horizontal Through-Hole  | <b>A</b> |
| Horizontal Surface Mount | <b>C</b> |

### Standard Application



**External Capacitors:** The PT7744 requires a minimum output capacitance of 330 $\mu$ F for proper operation. The PT7744 also requires an input capacitance of 1500 $\mu$ F which must be rated for a minimum of 1.4Arms of ripple current. For transient or dynamic load applications additional capacitance may be required. For further information refer to the application note regarding capacitor selection for this product.

**Input Filter:** An input filter inductor is optional for most applications. The inductor must be sized to handle 20ADC with a typical value of 1 $\mu$ H.

## Capacitor Recommendations for the PT7711/12 Regulators and PT7744/45 Current Boosters

### Input Capacitors

The recommended input capacitance is determined by 1.4 ampere minimum ripple current rating and 1500 $\mu$ F minimum capacitance. Capacitors listed below must be rated for a minimum of 2x the input voltage with +5V operation. Ripple current and  $\leq 100\text{m}\Omega$  Equivalent Series Resistance (ESR) values are the major considerations along with temperature when selecting the proper capacitor.

### Output Capacitors

The minimum required output capacitance is 330 $\mu$ F with a maximum ESR less than or equal to 100m $\Omega$ . Failure to observe this requirement may lead to regulator instability or oscillation. Electrolytic capacitors have poor ripple performance at frequencies greater than 400kHz, but excellent low frequency transient response. Above the ripple frequency ceramic decoupling capacitors are necessary to improve the transient response and reduce any microprocessor high frequency noise components apparent during higher current excursions. Preferred low ESR type capacitor part numbers are identified in the Table 1 below.

### Tantalum Characteristics

Tantalum capacitors with a minimum 10V rating are recommended on the output bus, but only the AVX TPS Series, Sprague 594/595 Series, or Kemet T495/T510 Series. The AVX TPS Series, Sprague Series or Kemet Series capacitors are specified over other types due to their higher surge current, excellent power dissipation and ripple current ratings. As an example, the TAJ Series by AVX is not recommended. This series exhibits considerably higher ESR, reduced power dissipation and lower ripple current capability. The TAJ Series is a less reliable compared to the TPS series when determining power dissipation capability.

### Capacitor Table

Table 1 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The suggested minimum quantities per regulator for both the input and output buses are identified.

*This is not an extensive capacitor list. The table below is a selection guide for input and output capacitors. Other capacitor vendors are available with comparable RMS ripple current rating and ESR (Equivalent Series Resistance at 100kHz). These critical parameters are necessary to insure both optimum regulator performance and long capacitor life.*

**Table 1 Capacitors Characteristic Data**

| Capacitor Vendor/<br>Series              | Capacitor Characteristics |                 |                                    |                                    |                          | Quantity  |            | Vendor Number                    |
|--|---------------------------|-----------------|------------------------------------|------------------------------------|--------------------------|-----------|------------|----------------------------------|
|  | Working Voltage           | Value( $\mu$ F) | (ESR) Equivalent Series Resistance | 105°C Maximum Ripple Current(Irms) | Physical Size(mm)        | Input Bus | Output Bus |                                  |
| Panasonic<br>FC<br>Surface Mtg<br>FA     | 16V                       | 2200            | 0.038 $\Omega$                     | 2000mA                             | 18x16.5                  | 1         | 1          | EEVFC1C222N                      |
|  | 35V                       | 330             | 0.065 $\Omega$                     | 1205mA                             | 12.5x16.5                |           | 1          | EEVFC1V331LQ                     |
|  | 10V                       | 680             | 0.090 $\Omega$                     | 755mA                              | 10x12.5                  |           | 1          | EEUFA1A681                       |
|  | 16V                       | 1800            | 0.032 $\Omega$                     | 2000mA                             | 18x15                    | 1         | 1          | EEUFA1C182A                      |
| United<br>Chem -Con<br>LFV Series        | 25V                       | 330             | 0.084 $\Omega$                     | 825mA                              | 10x16                    |           | 1          | LXV25VB331M10X16LL               |
|  | 16V                       | 2200            | 0.038 $\Omega$                     | 1630mA                             | 16x20                    | 1         | 1          | LXV16VB222M16X20LL               |
|  | 16V                       | 470             | 0.084 $\Omega/2=0.042\Omega$       | 825mA x2                           | 10x16                    |           | 1          | LXV16VB471M10X16LL               |
| Nichicon<br>PL Series<br>PM Series       | 10V                       | 680             | 0.090 $\Omega$                     | 770mA                              | 10x15                    |           | 1          | UPL1A681MHH6                     |
|  | 10V                       | 1800            | 0.044 $\Omega$                     | 1420mA                             | 16x15                    | 1         | 1          | UPL1A182MHH6                     |
|  | 25V                       | 330             | 0.095 $\Omega$                     | 750mA                              | 10x15                    |           | 1          | UPL1E331MPH6                     |
| Oscon SS<br>SV                           | 10V                       | 330             | 0.025W/4=0.006 $\Omega$            | >9800mA                            | 10x10.5                  | 4         | N/R        | 10SS330M                         |
|  | 10V                       | 330             | 0.020/4=0.005 $\Omega$             | >9800mA                            | 10.3x12.6                | 4         | (Note)     | 10SV330M(Sufvace Mtg)            |
| AVX<br>Tanatalum<br>TPS- Series          | 10V                       | 330             | 0.100/5=20 $\Omega$                | 3500mA                             | 7.3Lx                    | 5         | 1          | TPSV337M010R0100                 |
|  | 10V                       | 330             | 0.060 $\Omega$                     | 1826mA                             | 4.3Wx<br>4.1H            | 5         | 1          | TPSV337M010R0060                 |
| Sprague<br>Tantalum<br>595D/594D         | 10V                       | 330             | 0.045W/4=0.011 $\Omega$            | >4500mA                            | 7.3L x<br>5.7W x         | 5         | 1          | 594D337X0010R2T                  |
|  | 10V                       | 680             | 0.090 $\Omega$                     | >1660mA                            | 4.0H                     | 2         | 1          | Surface Mount<br>595D687X0010R2T |
| Kemet<br>Tantalum<br>T510/T495<br>Series | 10V                       | 330             | 0.035 $\Omega$                     | 2000mA                             | 4.3Wx7.3L<br>x4.0H       | 5         | 1          | 510X337M010AS                    |
|  | 10V                       | 220             | 0.070 $\Omega/2=0.035\Omega$       | >2000mA                            |                          | 6         | 2          | T495X227M010AS<br>Surface Mount  |
| Sanyo Poscap<br>TPB                      | 10V                       | 220             | 0.040 $\Omega$                     | 3000mA                             | 7.2L x<br>4.3W x<br>3.1H | 6         | 2          | 10TPB220M<br>Surface Mount       |

**Note:** (N/R) is not recommended for this application, due to extremely low Equivalent Series Resistance (ESR)



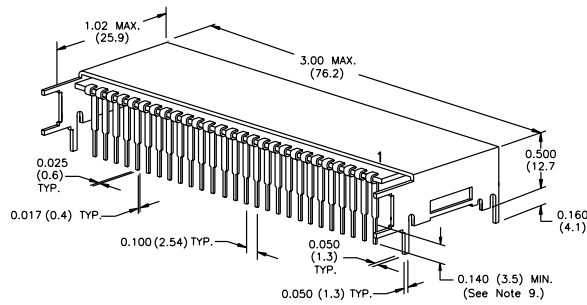
# Package Style 1430

Suffix A, C

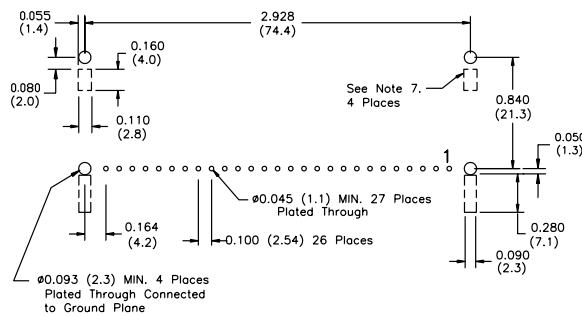
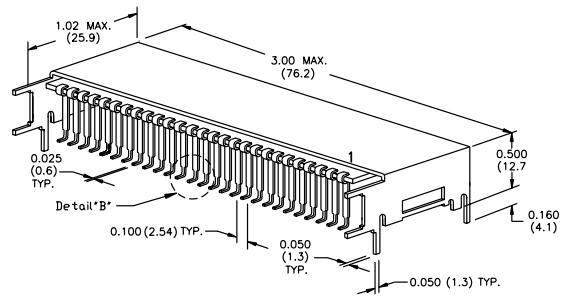
(Revised 6/30/2000)

## PACKAGE INFORMATION AND DIMENSIONS

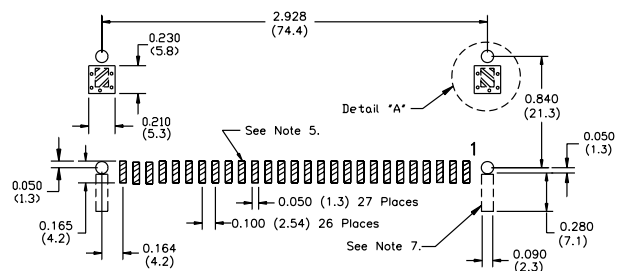
Horizontal Through-Hole Mount (Suffix A)



Horizontal Surface Mount (Suffix C)



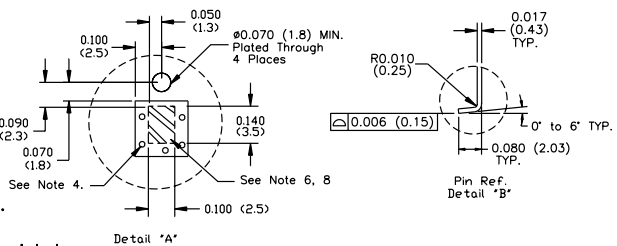
PC Layout



PC Layout

### Notes: (Rev. G)

- 1: All dimensions are in inches (mm).
- 2: 2 place decimals are  $\pm 0.030$  ( $\pm 0.8$ mm).
- 3: 3 place decimals are  $\pm 0.010$  ( $\pm 0.3$ mm).
- 4: Vias are recommended to improve copper adhesion.
- 5: Power pin connections should utilize two or more vias per input, ground and output pin.
- 6: Solder mask openings to copper island for solder joints to mechanical pins.
- 7: Recommended mechanical keep out area (dotted lines).
- 8: Electrically connect case to ground plane.
- 9: Electrical pin length (Horizontal Through-Hole) mounted on printed circuit board seating plane to pin end.



Power Trends proprietary package design.  
All rights reserved. Patent pending.

## **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgment, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Customers are responsible for their applications using TI components.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.